Application Data Sheet

Application Information

Application number:: Filing Date:: Regular Application Type:: Utility Subject Matter:: Suggested classification:: Suggested Group Art Unit:: CD-ROM or CD-R??:: Number of CD disks:: Number of copies of CDs:: Sequence Submission:: Computer Readable Form (CRF)?:: Number of copies of CRF:: METHOD FOR FABRICATING Title:: SEMICONDUCTOR DEVICE WITH IMPROVED REFRESH TIME 00939H-087500US Attorney Docket Number:: Request for Early Publication:: No Request for Non-Publication:: No Suggested Drawing Figure:: 6 **Total Drawing Sheets:** No Small Entity?:: Latin name:: Variety denomination name:: Petition included?:: No Petition Type:: Licensed US Govt. Agency:: Contract or Grant Numbers One::

Secrecy Order in Parent Appl.:: No

Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: South Korea

Status:: Full Capacity

Given Name:: Jae-Geun

Middle Name::

Family Name:: OH

Name Suffix::

City of Residence:: Kyoungki-do

State or Province of Residence::

Country of Residence:: South Korea

Street of Mailing Address:: San 136-1, Ami-ri, Bubal-eub, Ichon-shi

City of Mailing Address:: Kyoungki-do

State or Province of mailing address::

Country of mailing address:: South Korea

Postal or Zip Code of mailing address:: 467-860

Applicant Authority Type:: Inventor

Primary Citizenship Country:: South Korea

Status:: Full Capacity

Given Name:: Byung-Seop

Middle Name::

Family Name:: HONG

Name Suffix::

City of Residence:: Kyoungki-do

State or Province of Residence::

Country of Residence:: South Korea

Street of Mailing Address:: San 136-1, Ami-ri, Bubal-eub, Ichon-shi

City of Mailing Address:: Kyoungki-do

Page 2 Initial 12/29/03

State or Province of mailing address::

Country of mailing address:: South Korea

Postal or Zip Code of mailing address:: 467-860

Correspondence Information

Correspondence Customer Number:: 20350

Representative Information

Representative Customer Number:: 20350

Domestic Priority Information

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

Foreign Priority Information

Country:: Application number:: Filing Date::

Korea, South 2003-43081 06/30/03

Assignee Information

Assignee Name:: Hynix Semiconductor Inc.

Street of mailing address:: San 1367-1, Ami-ri, Bubal-eub

City of mailing address:: Ichon-shi

State or Province of mailing address:: Kyoungki-do

Country of mailing address:: Republic of Korea

Postal or Zip Code of mailing address:: 467-860